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Translation
Y. Robinson
3/5/03

PATENT
36856,449

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Keiji SAKATA	
Serial No.: 09/782,792	Art Unit: 2832
Filing Date: February 14, 2001	Examiner: T. Nguyen
For: MULTILAYER INDUCTOR	

DECLARATION UNDER 37 C.F.R. § 1.131

Assistant Commissioner for Patents
Washington, D.C. 20231

I hereby declare that I am the sole inventor of the present application.

I hereby declare that I invented all of the subject matter disclosed in U.S. Patent Application No. 09/782,792.

I hereby declare that I completed my invention disclosed in U.S. Patent Application No. 09/782,792 before February 1, 2000.

I hereby declare that I am currently and was at the time I invented the above mentioned invention an employee of Murata Manufacturing Co., Ltd., 26-10, Tenjin 2-chome, Nagaokakyo-shi, Kyoto-fu 617-8555 JAPAN.

In support of my declaration I have provided the following exhibits:

(a) a copy of a letter, dated January 29, 2000, from Mr. Eiichi Matsui of Okada Patent Office to Mr. Masaaki Kimura of Murata Manufacturing Co., Ltd. that accompanied the draft of Japanese Patent Application No. 2000-035593 (exhibit (c));

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(b) a copy of a letter, dated February 10, 2000, from Mr. Masaaki Kimura of Murata Manufacturing Co., Ltd. to Mr. Eiichi Matsui of Okada Patent Office instructing Mr. Eiichi Matsui to file Japanese Patent Application No. 2000-035593 (exhibit (c));

(c) a copy of the amended draft of Japanese Patent Application No. 2000-035593;

(d) a copy of the certified English translation of exhibit (a);

(e) a copy of the certified English translation of exhibit (b); and

(f) a copy of the certification of exhibits (d) and (e).

I hereby declare that only two changes were made to the draft of Japanese Patent Application No. 2000-035593 that was sent to Mr. Masaaki Kimura on January 29, 2000.

I hereby declare that the handwritten correction on page 6 of Japanese Patent Application No. 2000-035593 translates to "of the conductor coil pattern" and that the handwritten correction to fig. 5 of Japanese Patent Application No. 2000-035593 consisted of changing the units from "μm" to "mm."

I hereby declare that the amended draft of Japanese Patent Application No. 2000-035593 (exhibit (c)) was filed in the Japanese Patent Office on February 14, 2000 without further amendments.

I hereby declare that U.S. Patent Application No. 09/782,792 was filed in the United States Patent & Trademark Office on February 14, 2002 and that U.S. Patent Application No. 09/782,792 is based entirely and solely on Japanese Patent Application No. 2000-035593.

I hereby declare that the draft of Japanese Patent Application No. 2000-035593 sent by Mr. Eiichi Matsui of Okada Patent Office to Mr. Masaaki Kimura of Murata Manufacturing Co. Ltd. on January 29, 2000 corresponds exactly to U.S. Patent Application No. 09/782,792 except for the two minor handwritten changes described in the preceding paragraphs.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Keiji Sakata
Keiji SAKATA